

1.6X0.8mm SMD CHIP LED LAMP

Part Number: APT1608SECK/J3-PRV Hyper Red

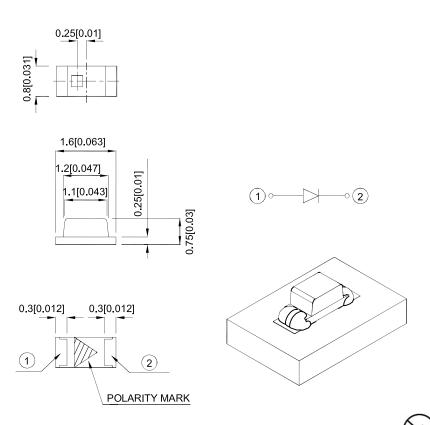
Features

- 1.6mmX0.8mm SMT LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red device is based on light emitting diode chip made from AlGaInP.

Package Dimensions





- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAN0479 **REV NO: V.2A** DATE: APR/09/2015 PAGE: 1 OF 5 **APPROVED: WYNEC CHECKED: Allen Liu** DRAWN: Q.M.Chen ERP: 1203013843

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		,	Min.	Тур.	201/2
APT1608SECK/J3-PRV	Hyper Red (AlCalaD)	Water Clear	700	1100	120°
	Hyper Red (AlGaInP)	Water Clear	*200	*350	

Notes:

- 1. 01 / 2 is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.

 2. Luminous intensity / luminous Flux: + / -15%.

 * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	625		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=20mA
С	Capacitance	Hyper Red	27		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	2.2	2.8	V	IF=20mA
lR	Reverse Current	Hyper Red		10	uA	VR = 5V

- 1. Wavelength: + / -1nm.
 2. Forward Voltage: + / -0.1V.
- 2. Forward voltage. Fr -0.1V.
 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

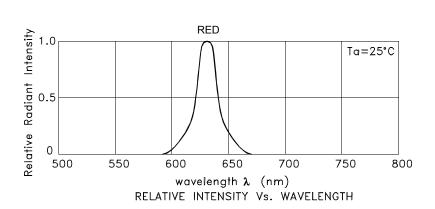
Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Units			
Power dissipation	84	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	150	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

Note:

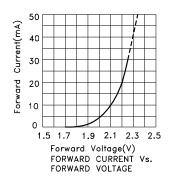
1. 1 / 10 Duty Cycle, 0.1ms Pulse Width.

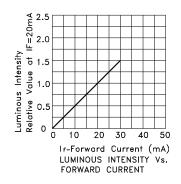
SPEC NO: DSAN0479 DATE: APR/09/2015 **REV NO: V.2A** PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Q.M.Chen ERP: 1203013843

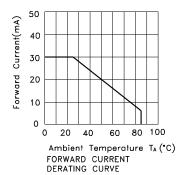


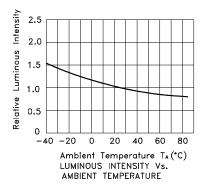
Hyper Red

APT1608SECK/J3-PRV



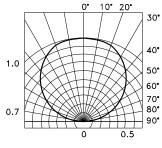






PAGE: 3 OF 5

ERP: 1203013843



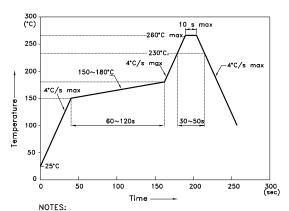
SPATIAL DISTRIBUTION

SPEC NO: DSAN0479 REV NO: V.2A DATE: APR/09/2015
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Q.M.Chen

APT1608SECK/J3-PRV

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



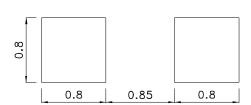
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

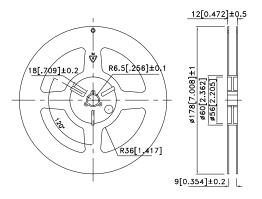
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

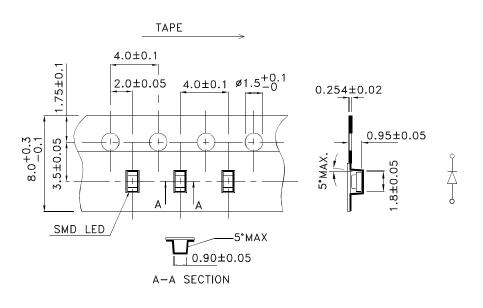
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units: mm)

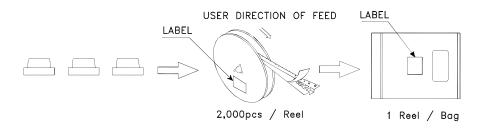


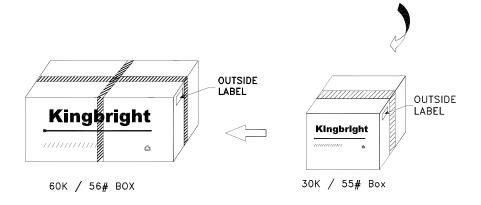
SPEC NO: DSAN0479 APPROVED: WYNEC **REV NO: V.2A CHECKED: Allen Liu** DATE: APR/09/2015 DRAWN: Q.M.Chen

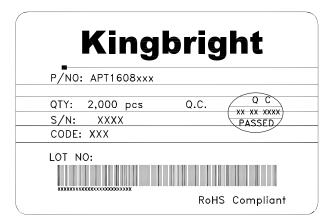
PAGE: 4 OF 5 ERP: 1203013843

PACKING & LABEL SPECIFICATIONS

APT1608SECK/J3-PRV







Terms and conditions for the usage of this document

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

 SPEC NO: DSAN0479
 REV NO: V.2A
 DATE: APR/09/2015
 PAGE: 5 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Q.M.Chen
 ERP: 1203013843